

Preliminary

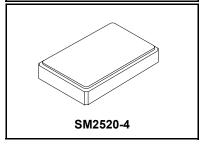


XTL1021G-1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL): Level-1

16.000000 MHz Crystal



Description and Applications:

Surface mount 2.5mmx2.0mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

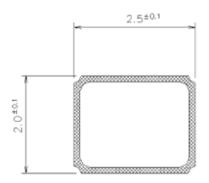
XTL1021G-1	Specification	
Nominal Frequency	16.000000 MHz	
Mode of Oscillation	Fundamental	
Storage Temperature Range	-40°C to +105°C	
Operating Temperature Range	-20°C to +70°C	
Frequency Stability over Operating Temperature Range	+/-10 ppm (referred to the value at 25°C)	
Frequency Make Tolerance (FL)	+/-10 ppm @ 25°C +/- 3°C	
Equivalent Series Resistance (ESR)	100 Ω max	
Nominal Drive Level	10uW typical and 200uW max	
Shunt Capacitance (Co)	3.0 pF max	
Load Capacitance (CL)	12 pF	
Aging	+/-2ppm/year	
Insulation Resistance	500 MΩ min./DC 100V	
Marking	Laser Marking	
Unit Weight	9.5 +/-0.5mg	



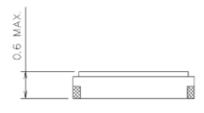
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

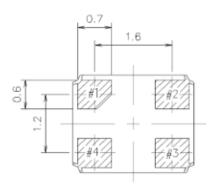
- 1. The design, manufacturing process, and specifications of this device are subject to change. 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

Mechanical Dimensions (mm): Base

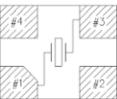


	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND

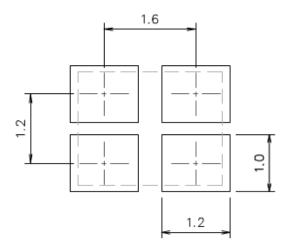






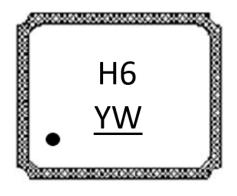


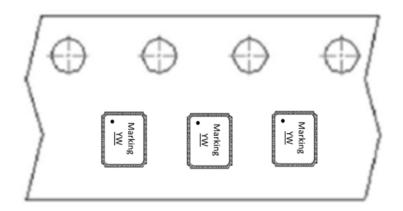
Recommended Land Pattern: (unit: mm)



Marking:

Y = Year W = Week

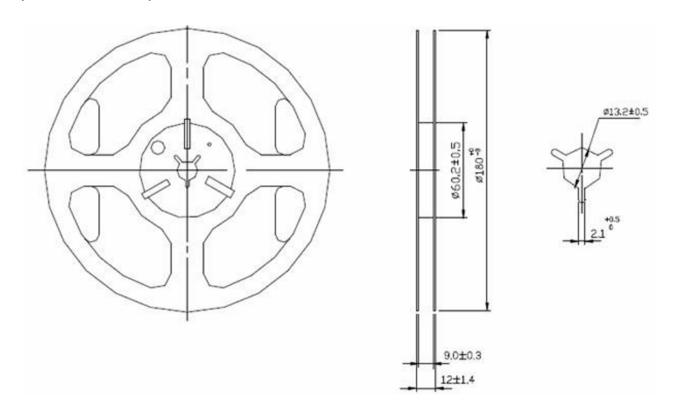




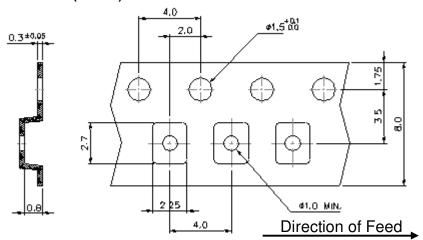
Reel Dimensions (mm):

Tape and Reel Standard per ANSI/EIA-481

Reel Count: 7" = 3000



Tape Dimensions (mm):

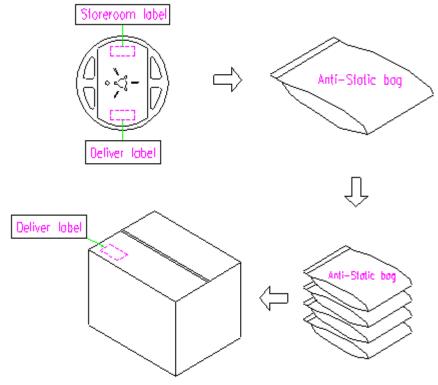


[NOTE]:

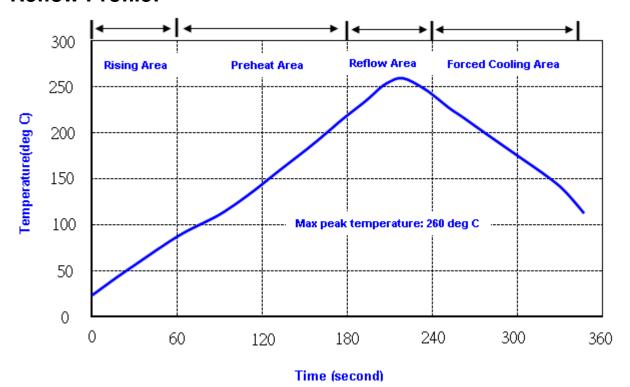
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

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Test name	Test process / method	Reference standard	
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Mechanical characteristics			
resistance to Soldering heat	Temp./ Duration: 265°C/10sec ×2 times Total time: 4min.(IR-reflow)	EIAJED-4701	
(IR reflow)	,	-300(301)M(II)	
Vibration	Total peak amplitude: 1.5mm Vibration frequency: 10 to 2000 Hz Sweep period: 20 minute Vibration directions: 3 mutually perpendicular Duration: 2 hr/direc.	MIL-STD 202G method 204	
Mechanical Shock	directions: 3 impacts per axis Acceleration: 3000g's, +20/-0 % Duration: 0.3 ms (total 18 shocks) Waveform: Half-sine	MIL-STD 202G method 213	
Solderability	Solder Temperature:265±5 ℃ Duration time: 5±0.5 seconds.	J-STD-002	
Environmental characteristics			
Thermal Shock	Heat cycle conditions -40 $^{\circ}$ C (30min) \longleftrightarrow 85 $^{\circ}$ C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8	
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103	
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A	
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 °C Duration : 96 hours	IEC 60068-2-1	